



# 2014 Bond Technology Infrastructure Spending Balance as of March 9, 2016

The following is the 2014 Bond Technology Infrastructure spending balance as of March 9, 2016. To assure accountability, purchase orders and expenditures by each Bond goal is balanced with the Finance department's records.

	2014 Bond Technology Goals	Balance	% Spent	Estimated Cost in 2014 Bond
1.1	Install High Speed Wireless Access Infrastructure	\$3,145,325.19	75.68%	\$12,934,270.00
2.1	Install Network Electronics Infrastructure	\$14,901,005.17	48.06%	\$28,689,853.45
3.1	Upgrade Fiber and Cabling Connectivity	-\$2,519,965.71	153.96%	\$4,670,150.00
3.2	Upgrade Electrical Power and Air Conditioning	\$918,003.05	81.53%	\$4,969,862.99
4.1	Build a Virtualized Server Data Center	\$3,003,361.58	3.28%	\$3,105,236.33
4.2	Install a Storage Area Network (SAN)	\$4,684,504.41	0.00%	\$4,684,504.41
4.3	Co-Locate Data Center at an External Facility	\$235,017.58	66.35%	\$698,413.20
4.4	Build Backup, Recovery, and Business Continuity	\$557,110.21	66.45%	\$1,660,506.21
5.1	Replace Telephone System w/VoIP Communications	\$4,677,786.69	37.37%	\$7,469,293.81
5.2	Replace Administrative Staff Technology	\$5,607,336.86	30.75%	\$8,097,716.00
5.3	Replace Network Printers and Print Servers	\$3,895,345.28	6.87%	\$4,182,715.00
6.1	Install Technology Infrastructure in New Schools	\$2,501,936.47	24.53%	\$3,315,248.00
7.1	Design Contingency	\$5,169,637.71	12.58%	\$5,913,443.89
<b>Grand Totals</b>		<b>\$46,776,404.49</b>	<b>48.25%</b>	<b>\$90,391,213.29</b>